SUMICRYSTAL	M
M65 to M71	IV

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SUMICRYSTAL	M66
SUMICRYSTAL PD/PDX	M67
SUMICRYSTAL UP	M68
SUMICRYSTAL UP (Half Cut)	M69
SUMICRYSTAL UPT	M70
SUMICRYSTAL CD	M71

SUMICRYSTAL

■ General Features

SUMICRYSTAL is the world's first commercially available large single-crystal synthetic diamond, developed by Sumitomo.

Thorough quality control has achieved stable quality, making SUMICRYSTAL ideal as an industrial material.

■ Production Method

The synthetic single-crystal diamond SUMICRYSTAL is synthesised in a super high pressure chamber from 5 to 6GPa and high temperatures from 1,300 to 1,600°C. The temperature difference between the raw carbon and the seed crystal is used to grow the diamond on the seed crystal. Through this stringent control of pressures and temperatures, a more stable structure with minimal impurities can be obtained.

■ Properties

SUMICRYSTAL has 4 main advantages over natural diamond.

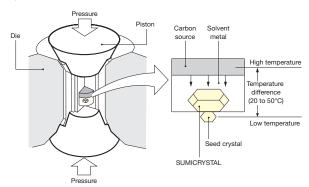
- Structural advantage: Natural diamond is rounded and the crystal orientation is difficult to determine with the naked eye.
 SUMICRYSTAL, however, has a distinct crystal face which makes the identification much easier.
- 2) Uniformity: Due to the strictly controlled conditions in which the crystals are grown, uniform quality is obtained consistently.
- Availability: Unlike the limited supply of natural diamonds, SUMICRYSTAL can be mass produced.
- 4) SUMICRYSTAL diamond type Ib, which is used for tools, has mechanical and thermal properties equal to or even greater than natural diamond, while containing small amounts of nitrogen impurities.



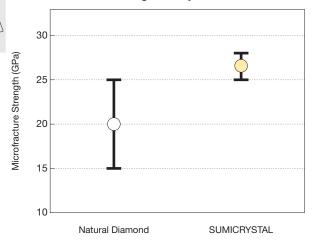
• Inside a super high pressure chamber

Synthetic Conditions Pressure: 5 to 6GPa

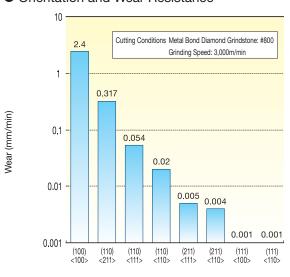
Temperature: 1,300 to 1,600°C



Microfracture Strength of Synthetic Diamond

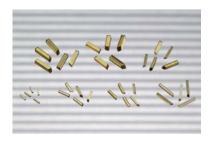


Orientation and Wear Resistance



Orientation/Direction

PD/PDX



■ General Features

SUMICRYSTAL PD and PDX are single-crystal synthetic diamonds processed into thin prism shapes for use as dresser blanks. Their stable performance and long tool life improve dressing precision.

SUMICRYSTAL PD

■ Features

- Revolutionary elongated shape
- (1) Improves holding power and prevents falling out.
- (2) Consistent cross-section prevents deterioration.
- (3) Uniform crystal orientation promotes stable tool life.

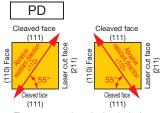
■ Standard Cat. No. (PD)

Dimensions (mm)

Shape	Cat. No.	Stock	Т	W	L
PD	PD 0220	•	0.2 ^{±0.05}	0.2 ^{±0.05}	2.0 to 2.5
Laser cut	PD 0420		0.4 ^{±0.05}	0.4 ^{±0.05}	2.0 to 2.5
ı W	PD 0630K				3.0 to 4.0
	PD 0640K		0.6 ^{±0.1}	$0.6^{\pm0.1}$	4.0 to 5.0
Dimension L is the distance between the centre points of	PD 0650K				5.0 up
	PD 0830K			0.8 ^{±0.1}	3.0 to 4.0
	PD 0840K				4.0 to 5.0
	PD 0850K				5.0 up
both ends. Both upper and lower (111) faces	PD 1130K				3.0 to 4.0
are cleaved.	PD 1140K		1.1=0		4.0 to 5.0
PD-T	PD 0630TK		0.6 ^{±0.1}	0.6 ^{±0.1}	3.0 to 4.0
Cleaved face Laser cut face	PD 0640TK		0.6=	0.6-0.1	4.0 to 5.0
(111) (211)	PD 0830TK		0.8 ^{±0.1}	0.8±0.1	3.0 to 4.0
(110) Face Cleaved face (111)	PD 0840TK		0.0=0.1	0.0=0.1	4.0 to 5.0
	PD 1130TK	•			3.0 to 4.0
Single cleaved side face with pre- determined abrasive resistant direction.	PD 1140TK	•	1.1 ^{±0.1}	1.1 ^{±0.1}	4.0 to 5.0

- *1 Sizes other than those indicated above can be ordered.
- *2 These products may have fine impurities within Sumitomo's prescribed range.
- *3 The laser cut faces among other product areas may have chipping within Sumitomo's prescribed range.

■ PD Crystal Orientation



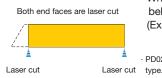
The two types above both exist in the wear-resistant direction.

Cleaved face (111) Laser cut face (211) Cleaved face (110) Cleaved face (111)

 Single cleaved side face with predetermined abrasive resistant direction.

■ KK type

Apart from the standard items listed above, PD is also available in the KK type with both end faces laser-cut.



 When ordering, please include "K" behind the standard catalogue no. (Example: PDOOOOKK, PDOOOOTKK)

PD0220 and PD0420 are not available in the KK

SUMICRYSTAL PDX

■ Features

- Compared to SUMICRYSTAL PD, the product has different face crystal orientation.
- (1) Crystal orientation (211) provides better tool life than PD blanks.
- (2) Parallel abrasive resistant faces (111) facilitate blank setting during manufacturing of dressers.

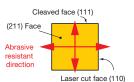
■ Standard Cat. No. (PDX)

Dimensions (mm)

	Shape	Cat. No.	Stock	Т	W	L
	PDX Laser cut	PDX 0220		0.2 ^{±0.05}	0.2 ^{±0.05}	2.0 ^{±0.1}
		PDX 0320		0.3 ^{±0.05}	0.3 ^{±0.05}	2.0 ^{±0.1}
	T	PDX 0420		$0.4^{\pm0.05}$	0.4 ^{±0.05}	2.0 ^{±0.1}
		PDX 0630		0.6±0.1	0.6 ^{±0.1}	3.0 ^{±0.5}
		PDX 0640		0.6-0.1		4.0 ^{±0.5}
		PDX 0830		0.8±0.1		3.0 ^{±0.5}
	· Dimension L is the distance	PDX 0840		0.6=0.1	0.6=0.1	4.0 ^{±0.5}
	between the centre points of both ends.	PDX 1130				3.0±0.5
	Both upper and lower (111) faces are cleaved.	PDX 1140	•	1.1±0.1	1.1 ^{±0.1}	4.0 ^{±0.5}

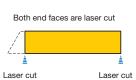
- *1 Sizes other than those indicated above can be ordered.
- *2 These products may have fine impurities within Sumitomo's prescribed range.
- *3 The laser cut faces among other product areas may have chipping within Sumitomo's prescribed range.

■ PDX Crystal Orientation



■ K type

Apart from the standard items listed above, PDX is also available in the K type with both end faces laser-cut.



- · When ordering, please include "K" behind the standard catalogue no. (Example: PDXOOOK)
- · PDX0220, PDX0320 and PDX0420 are not available in the K type.



■ General Features

Of today's sophisticated cutting-edge technologies, ultra-precision machining processes such as those used for optical element molds are seeing particularly rapid development.

SUMICRYSTAL UP blanks have high performance and reliability, making them optimally suited to these applications.

■ Features

- (1) High quality with very low variance.
 - Stable wear resistance with excellent resistance to cutting edge chipping.
- (2) Minimal stock removal during cutting edge formation. Uniform shape facilitates cutting edge formation.

■ Standard type

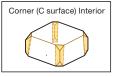
Rectangular parallel type with 6 (100) faces.

■ Standard Cat. No. (Standard type)

Dimensions (mm)

Shape	Cat. No.	Stock	L	W	C ₁ ,C ₂	Т
UP Top and Bottom Surfaces:	UP 282512		2.8 to 3.5	2.5 to 3.5	up to 0.8	1.2 ^{±0.1}
Ground Surface	UP 282515		2.8 to 3.5	2.5 to 3.5	up to 0.8	1.5 ^{±0.1}
T C1	UP 303015		3.0 to 3.5	3.0 to 3.5	up to 0.3	1.5 ^{±0.1}
	UP 301415		3.0 to 3.5	1.4 to 1.7	up to 0.3	1.5 ^{±0.1}
Laser cut face (100)	UP 333014		3.3 to 4.0	3.0 to 4.0	up to 0.9	1.4 ^{±0.1}
The red arrows indicate	UP 333017		3.3 to 4.0	3.0 to 4.0	up to 0.9	1.7 ^{±0.1}
the direction for easy grinding.	UP 353514		3.5 to 4.0	3.5 to 4.0	up to 0.4	1.4 ^{±0.1}
Crystal face orientations	UP 353517		3.5 to 4.0	3.5 to 4.0	up to 0.4	1.7 ^{±0.1}
are all (100) except the corners.	UP 351717		3.5 to 4.0	1.7 to 2.0	up to 0.4	1.7 ^{±0.1}

- *1 Sizes other than those indicated above can be ordered.
- *2 These products may have fine impurities, chipping, etc. within Sumitomo's prescribed
- *3 Impurities, cracks, etc. outside the inspection range may be present at the product corner (C surface) interior.



Wiper Insert for High-efficiency Cutter for Aluminum Alloy RF type

Cutting Tools Using SUMICRYSTAL UP



^{*} This product was jointly developed with A.L.M.T. Corp.

■ Economy type

Peripheral growth faces and top (100) are not cut. Benefits include large volume and low cost.

■ Standard Cat. No. (Economy type)

Standard Cat. No	or (Economy type	,	Dimensio	ons (mm
Shape	Cat. No.	Stock	øD Minimum guaranteed dimensions	Т
UP Economy type	UP 2010		2.0	1.0+0.2
	UP 2012		2.0	1.2+0.3
	UP 2510		2.5	1.0+0.2
	UP 2512		2.5	1.2+0.3
	UP 2515		2.5	1.5+0.3
	UP 3010		3.0	1.0+0.2
*	UP 3012		3.0	1.2+0.3
00	UP 3015		3.0	1.5+0.3
	UP 3510		3.5	1.0+0.2
	UP 3512		3.5	1.2+0.3
T /	UP 3515		3.5	1.5+0.3
	UP 4010		4.0	1.0+0.2
	UP 4012		4.0	1.2+0.3
Growth Surface	UP 4015		4.0	1.5+0.3
Top Surface: Growth Surface or Ground Surface	UP 4020		4.0	2.0+0.3
Bottom Surface: Ground	UP 4510		4.5	1.0+0.2
Surface	UP 4512		4.5	1.2+0.3
	UP 4515		4.5	1.5+0.3
	UP 4520		4.5	2.0+0.3
	UP 5010		5.0	1.0+0.2
The red arrows indicate	UP 5012		5.0	1.2+0.3
the direction for easy	UP 5015		5.0	1.5+0.3
grinding.	UP 5020		5.0	2.0+0.3

- *1 Sizes other than those indicated above can be ordered.
- *2 Fine impurities, chipping, etc. within Sumitomo's prescribed range may be present in the minimum guaranteed dimensions of these products.
- *3 Impurities, chipping, etc. outside the inspection range may be present outside the minimum guaranteed dimensions of these products.
- *4 Some products have ground top surfaces.

SUMICRYSTAL SC10 (Wiper Insert)





- · Utilises Sumitomo Electric Hardmetal's SUMICRYSTAL as a cutting edge. SUMICRYSTAL is a single-crystal diamond produced using a unique superhigh-pressure technology.
- · SUMICRYSTAL can maintain its edge sharpness better than sintered diamonds, greatly reducing burr formation.



SUMICRYSTAL (Single-crystal Diamond) SC10 Wiper Blade Machined Surface



SUMIDIA (Sintered Diamond) Wiper Blade Machined Surface

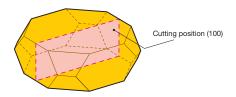
■ General Features

SUMICRYSTAL UP Half Cut products are materials for holders consisting of the UP Economy type material cut in half along the (100) or (110) faces.

■ Features

- (1) Machining loss is reduced because volume removed by grinding during tool production is reduced.
- (2) Similar shape to the completed tool, reducing material costs.
- (3) The cut surface is a smooth laser surface.

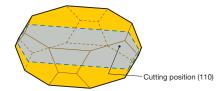
■ Type cut along (100) face



■ Standard Cat. No. (Cutting Position 100 type) Dimensions (mm)						
Shape	Cat. No.	Stock	øD Minimum guaranteed dimensions	Т		
UP Half-Cut (100) type	UP 2010 (100) 1/2		2.0	1.0+0.2		
	UP 2012 (100) 1/2		2.0	1.2 +0.3		
	UP 2510 (100) 1/2		2.5	1.0+0.2		
	UP 2512 (100) 1/2		2.5	1.2 +0.3		
	UP 2515 (100) 1/2		2.5	1.5+0.3		
	UP 3010 (100) 1/2		3.0	1.0+0.2		
	UP 3012 (100) 1/2		3.0	1.2 +0.3		
øD_	UP 3015 (100) 1/2		3.0	1.5+0.3		
	UP 3510 (100) 1/2		3.5	1.0+0.2		
	UP 3512 (100) 1/2		3.5	1.2 +0.3		
T T	UP 3515 (100) 1/2		3.5	1.5+0.3		
	UP 4010 (100) 1/2		4.0	1.0+0.2		
Laser cut face Growth Surface (100)	UP 4012 (100) 1/2		4.0	1.2 +0.3		
Top Surface: Growth	UP 4015 (100) 1/2		4.0	1.5+0.3		
Surface or Ground Surface	UP 4020 (100) 1/2		4.0	2.0+0.3		
Bottom Surface: Ground	UP 4510 (100) 1/2		4.5	1.0+0.2		
Surface	UP 4512 (100) 1/2		4.5	1.2 +0.3		
	UP 4515 (100) 1/2		4.5	1.5+0.3		
	UP 4520 (100) 1/2		4.5	2.0+0.3		
	UP 5010 (100) 1/2		5.0	1.0+0.2		
	UP 5012 (100) 1/2		5.0	1.2+0.3		
The red arrows indicate the	UP 5015 (100) 1/2		5.0	1.5+0.3		
direction for easy grinding.	UP 5020 (100) 1/2		5.0	2.0+0.3		

- *1 Sizes other than those indicated above can be ordered.
- *2 Fine impurities, chipping, etc. within Sumitomo's prescribed range may be present in the minimum guaranteed dimensions of these products.
- *3 Impurities, chipping, etc. outside the inspection range may be present outside the minimum guaranteed dimensions of these products.

■ Type cut along (110) face



■ Sta

andard Cat. No.	(Cutting Position 110 type)	Dimensio
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Dimensions (mm)					
Shape	Cat. No.	Stock	øD Minimum guaranteed dimensions	Т	
UP Half-Cut (110) type	UP 2010 (110) 1/2		2.0	1.0+0.2	
	UP 2012 (110) 1/2		2.0	1.2+0.3	
	UP 2510 (110) 1/2		2.5	1.0+0.2	
	UP 2512 (110) 1/2		2.5	1.2+0.3	
	UP 2515 (110) 1/2		2.5	1.5+0.3	
	UP 3010 (110) 1/2		3.0	1.0+0.2	
	UP 3012 (110) 1/2		3.0	1.2 +0.3	
	UP 3015 (110) 1/2		3.0	1.5+0.3	
øD	UP 3510 (110) 1/2		3.5	1.0+0.2	
	UP 3512 (110) 1/2		3.5	1.2+0.3	
T	UP 3515 (110) 1/2		3.5	1.5+0.3	
	UP 4010 (110) 1/2		4.0	1.0+0.2	
Laser cut face (110)	UP 4012 (110) 1/2		4.0	1.2 +0.3	
Top Surface: Growth	UP 4015 (110) 1/2		4.0	1.5+0.3	
Surface or Ground Surface	UP 4020 (110) 1/2		4.0	$2.0^{+0.3}_{-0.0}$	
Bottom Surface: Ground Surface	UP 4510 (110) 1/2		4.5	1.0+0.2	
Surface	UP 4512 (110) 1/2		4.5	1.2 +0.3	
	UP 4515 (110) 1/2		4.5	1.5+0.3	
	UP 4520 (110) 1/2		4.5	$2.0^{+0.3}_{-0.0}$	
	UP 5010 (110) 1/2		5.0	1.0+0.2	
	UP 5012 (110) 1/2		5.0	1.2+0.3	
The red arrows indicate the	UP 5015 (110) 1/2		5.0	1.5+0.3	
direction for easy grinding.	UP 5020 (110) 1/2		5.0	2.0 +0.3	

- *1 Sizes other than those indicated above can be ordered.
- $\ensuremath{^{\star}}\xspace2$ Fine impurities, chipping, etc. within Sumitomo's prescribed range may be present in the minimum guaranteed dimensions of these products.
- *3 Impurities, chipping, etc. outside the inspection range may be present outside the minimum guaranteed dimensions of these products.



■ General Features

SUMICRYSTAL UPT is a material for bites with a 2-point surface ((110) surface) as the main surface.

■ Features

- (1) 2-point surface ((110) face) enables use for the same applications as with bites using conventional natural diamonds.
- (2) Distinctive shape minimises the volume removed to make the cutting edge, enabling efficient machining.

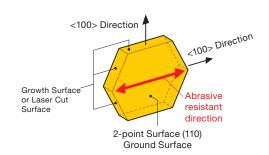
■ Standard Items

imens	ions	(m	m)
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Shape	Cat. No.	Stock	W	L	Т
UPT Top (L/2)	UPT 2510		\ O.F.	≥ 2.5	1.0±0.1
Impurities Bottom (L/2)	UPT 2512		≥ 2.5	≥ 2.5	1.2 ^{±0.1}
T	UPT 3010		\ 2 O	≥ 2.5	1.0 ^{±0.1}
<u> </u>	UPT 3012		≥ 3.0	∠ 2.5	1.2 ^{±0.1}

^{*1} Sizes other than those indicated above can be ordered.

■ UPT Crystal Orientation







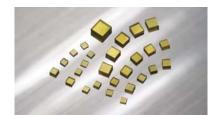






^{*2} Fine impurities, chipping, etc. within Sumitomo's prescribed range may be present at the

 $^{^{\}star}3$ Impurities, chipping, etc. outside the inspection range may be present at the bottom (L/2).



required for natural diamond.

■ General Features

SUMICRYSTAL CD has optimised crystal orientation and shape as a material for wire drawing dies. Realising excellent performance through high quality and stability.

■ Features

(1) High quality with very low variance. High-quality crystal with minimal impurities, chipping and distortion is used to achieve high, stable wear resistance. It also eliminates the need for inspection and selection of raw stones as

(2) High fracture strength

Resistant to fracture and cracking during wire drawing.

- (3) Accurate crystal orientation (111) is used on the top and bottom surface, limiting crystal misorientation, which causes variance in tool life, to within 1°.
- (4) No grinding needed for top and bottom surface The top and bottom surface are cleaved to form parallel surfaces, eliminating the need for grinding of the top and bottom surface.

■ Standard type

The outside is machined by laser, achieving a consistent shape for easy setting. Mounting pressure is applied evenly, ensuring sufficient strength even for small volume. Ideal for applications with limited dimensions, such as nozzles and wire guides.

Standard Items

Dimensions (mm)

Shape	Cat. No.	Stock	ØD Minimum guaranteed dimensions	L	Т
aD T	CD 1006(111)	•	0.9	1.0 ^{±0.1}	0.6 ^{±0.1}
	CD 1008(111)	•	0.9	1.0 ^{±0.1}	0.8 ^{±0.1}
	CD 1210(111)	•	1.1	1.2 ^{±0.1}	1.0 ^{±0.1}
	CD 1411(111)		1.3	1.4 ^{±0.1}	1.1 ^{±0.1}
	CD 1512(111)	•	1.4	1.5 ^{±0.1}	1.2 ^{±0.1}
Growth face (111)	CD 1814(111)		1.7	1.8 ^{±0.1}	1.4 ^{±0.1}
Surface Laser cut face	CD 2016(111)		1.9	2.0 ^{±0.1}	1.6 ^{±0.1}
The laser cutting surface	CD 2318(111)		2.2	2.3 ^{±0.1}	1.8 ^{±0.1}
orientation is undetermined.	CD 2520(111)		2.4	2.5 ^{±0.1}	2.0 ^{±0.1}

- *1 Sizes other than those indicated above can be ordered.
- *2 Dimension L is guaranteed on the small side surface of the volume.
- *3 Cleaved steps within Sumitomo's prescribed range may be present on the cleaved surface.
- *4 Fine impurities, chipping, etc. within Sumitomo's prescribed range may be present in the minimum guaranteed dimensions of these products.
- *5 Impurities, chipping, etc. outside the inspection range may be present outside the minimum guaranteed dimensions of these products.